OKI Semiconductor

1A

MSM27C1652CZ

1,048,576-Word x 16-Bit or 2,097,152-Word x 8-Bit

8-Word x 16-Bit or 16-Word x 8-Bit Page Mode One Time PROM

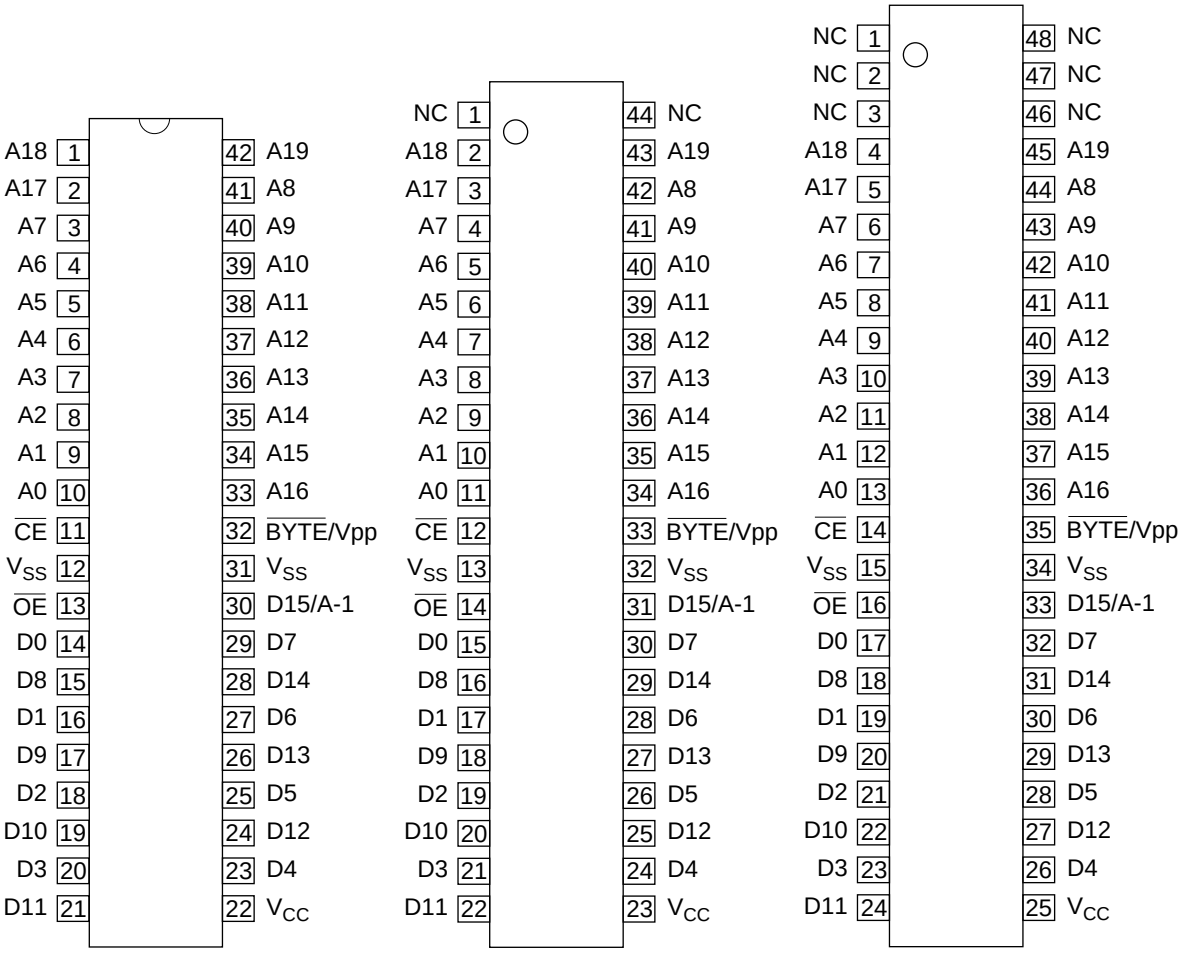
DESCRIPTION

The MSM27C1652CZ is a 16Mbit electrically Programmable Read-Only Memory with page mode. Its configuration can be electrically switched between 1,048,576 word x 16bit and 2,097,152 word x 8bit. The MSM27C1652CZ operates on a single +5V power supply and is TTL compatible. The MSM27C1652CZ provides Page mode which can greatly reduce the read access time. Since the MSM27C1652CZ operates asynchronously , external clocks are not required , making this device easy-to-use. The MSM27C1652CZ is suitable as large-capacity fixed memory for microcomputers and data terminals. It is manufactured using a CMOS double silicon gate technology and is offered in 42-pin DIP , 44-pin SOP or 48-pin TSOP packages.

FEATURES

- 1,048,576 word x 16bit / 2,097,152 word x 8bit electrically switchable configuration
- Single +5V power supply
- Access time 100ns
  Page mode access time 50ns
- Input / Output TTL compatible
- Three-state output
- Packages
  - 42-pin plastic DIP (DIP42-P-600-2.54)
  - 44-pin plastic SOP (SOP44-P-600-1.27-K)
  - 48-pin plastic TSOP (TSOP II 48-P-550-0.80-K)

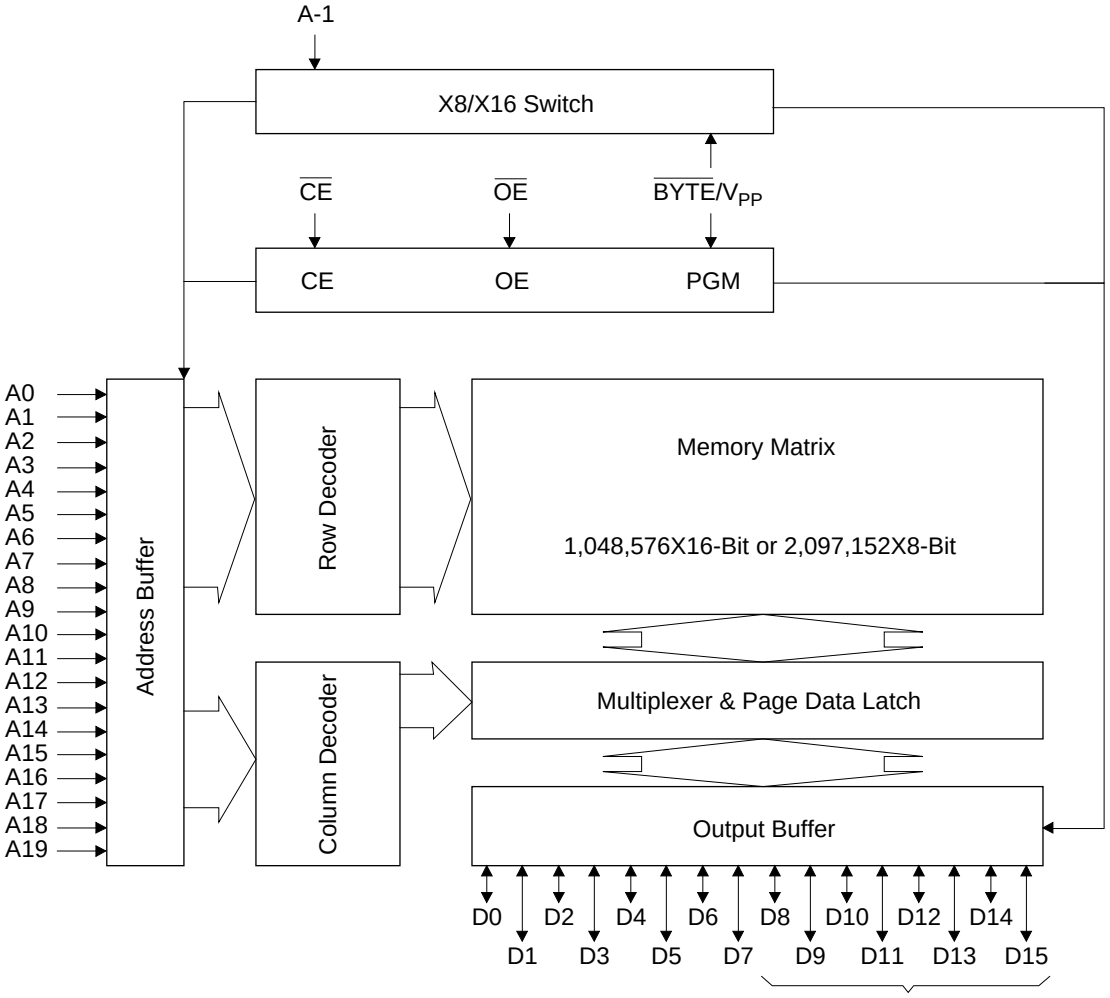
PIN CONFIGURATION (TOP VIEW)



42-pin DIP　　44-pin SOP　　48-pin TSOP

PIN NAMES	FUNCTIONS
D15/A-1	Data output / Address input
A0 - A19	Address input
D0 - D14	Data output
$\overline{CE}$	Chip enable
$\overline{OE}$	Output enable
V_{CC}	Power supply voltage
V_{SS}	GND
$\overline{BYTE}/V_{PP}$	Mode switch / Program power supply voltage
NC	Non connection

BLOCK DIAGRAM



In 8-bit output mode, these pins are three-stated and pin D15 functions as the A-1 address pin.

FUNCTION TABLE

MODE	$\overline{CE}$	$\overline{OE}$	$\overline{BYTE}/V_{PP}$	V_{CC}	D0 - D7	D8 - D14	D15/A-1
READ (16-Bit)	L	L	H	4.5V to 5.5V	D_{OUT}		
READ (8-Bit)	L	L	L		D_{OUT}	Hi-Z	L/H
OUTPUT DISABLE	L	H	H		Hi-Z		
			L				*
STAND-BY	H	*	H		Hi-Z		
			L				*
PROGRAM	L	H	11.5V	6.25V	D_{IN}		
PROGRAM INHIBIT	H	H			Hi-Z		
PROGRAM VERIFY	H	L			D_{OUT}		

* : Don't Care

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Value	Unit
Operating temperature under bias	Topr	-	0 to 70	°C
Storage temperature	T_{stg}		-55 to 125	°C
Input voltage	V_I	relative to V_{SS}	-0.5 to V_{CC} + 0.5	V
Output voltage	V_O		-0.5 to V_{CC} + 0.5	V
Power supply voltage	V_{CC}		-0.5 to 7	V
Program power supply voltage	V_{PP}		-0.5 to 12.5	V
Power dissipation per package	P_D	-	1.0	W

RECOMMENDED OPERATING CONDITIONS FOR READ

(Ta=0 to 70°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
V_{CC} power supply voltage	V_{CC}	V_{CC}=4.5V - 5.5V	4.5	-	5.5	V
V_{PP} power supply voltage	V_{PP}		-0.5	-	V_{CC}+0.5	V
Input "H" level	V_{IH}		2.2	-	V_{CC}+0.5	V
Input "L" level	V_{IL}		-0.5	-	0.8	V

Voltage is relative to Vss

ELECTRICAL CHARACTERISTICS (Read operation)

DC Characteristics

(V_{CC}=5V±0.5V, Ta=0 to 70°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input leakage current	I_{LI}	V_I=0 to Vcc	-	-	10	µA
Output leakage current	I_{LO}	V_O=0 to Vcc	-	-	10	µA
V_{CC} power supply current (Standby)	I_{CS1}	$\overline{CE}$=V_{CC}	-	-	50	µA
	I_{CS2}	$\overline{CE}$=V_{IH}	-	-	1	mA
V_{CC} power supply current (Read)	I_{CCA}	$\overline{CE}$=V_{IL} , $\overline{OE}$=V_{IH} tc=100ns	-	-	100	mA
V_{PP} power supply current	I_{PP}	V_{PP}=V_{CC}	-	-	10	µA
Input "H" level	V_{IH}	-	2.2	-	V_{CC}+0.5	V
Input "L" level	V_{IL}	-	-0.5	-	0.8	V
Output "H" level	V_{OH}	I_{OH}=-400µA	2.4	-	-	V
Output "L" level	V_{OL}	I_{OL}=2.1mA	-	-	0.45	V

Voltage is relative to Vss

AC Characteristics

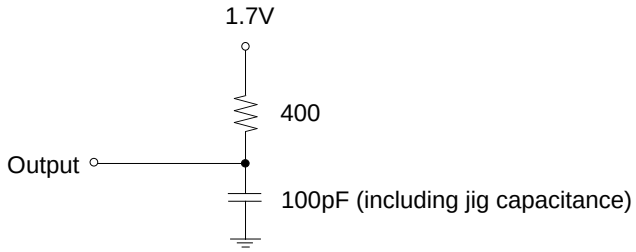
(V_{CC}=5V±0.5V, Ta=0 to 70°C)

Parameter	Symbol	Condition	Min.	Max.	Unit
Random access cycle time	T_C	-	100	-	ns
Address access time	T_{ACC}	$\overline{CE}$=$\overline{OE}$=V_{IL}	-	100	ns
Page set up time	T_{PSET}	NOTE(1)	120	-	ns
Page access cycle time	T_{PC}	-	50	-	ns
Page access time	T_{PAC}	-	-	50	ns
$\overline{CE}$ access time	T_{CE}	$\overline{OE}$=V_{IL}	-	100	ns
$\overline{OE}$ access time	T_{OE}	$\overline{CE}$=V_{IL}	-	50	ns
Output disable time	T_{CHZ}	$\overline{OE}$=V_{IL}	0	40	ns
	T_{OHZ}	$\overline{CE}$=V_{IL}	0	35	ns
Output hold time	T_{OH}	$\overline{CE}$=$\overline{OE}$=V_{IL}	0	-	ns

NOTE(1) T_{PSET} is defined as the end of either $\overline{CE}$ trailing edge or address transition in random access term until the first page address transition.

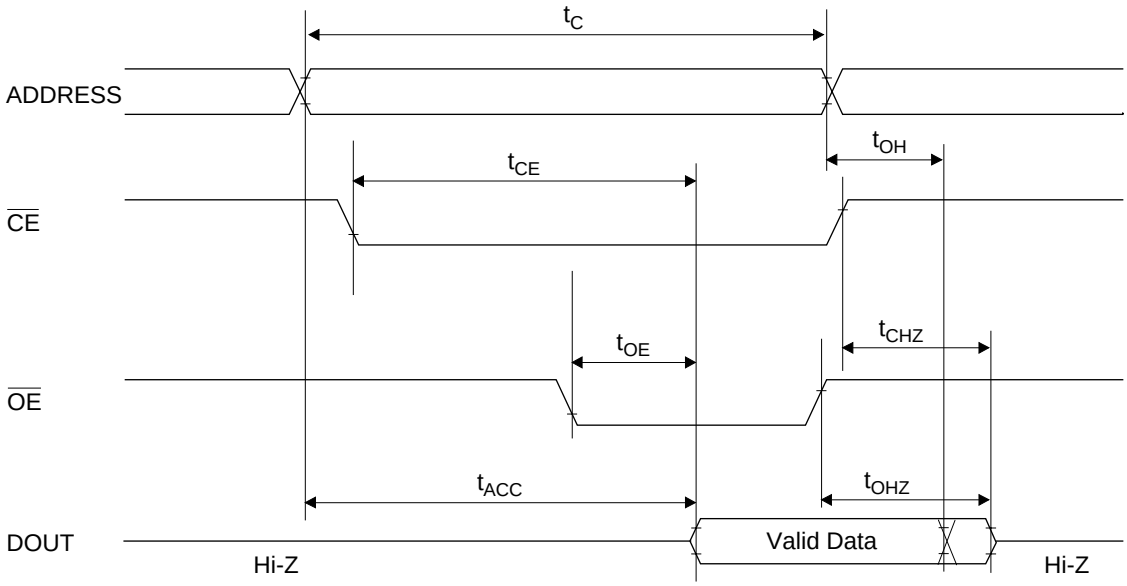
Measurement conditions

Input signal level ---------- 0V/3V
Input timing reference level ---------- 0.8V/2.0V
Output load ---------- 1TTL gate + 100pF
Output timing reference level ---------- 0.8V/2.0V

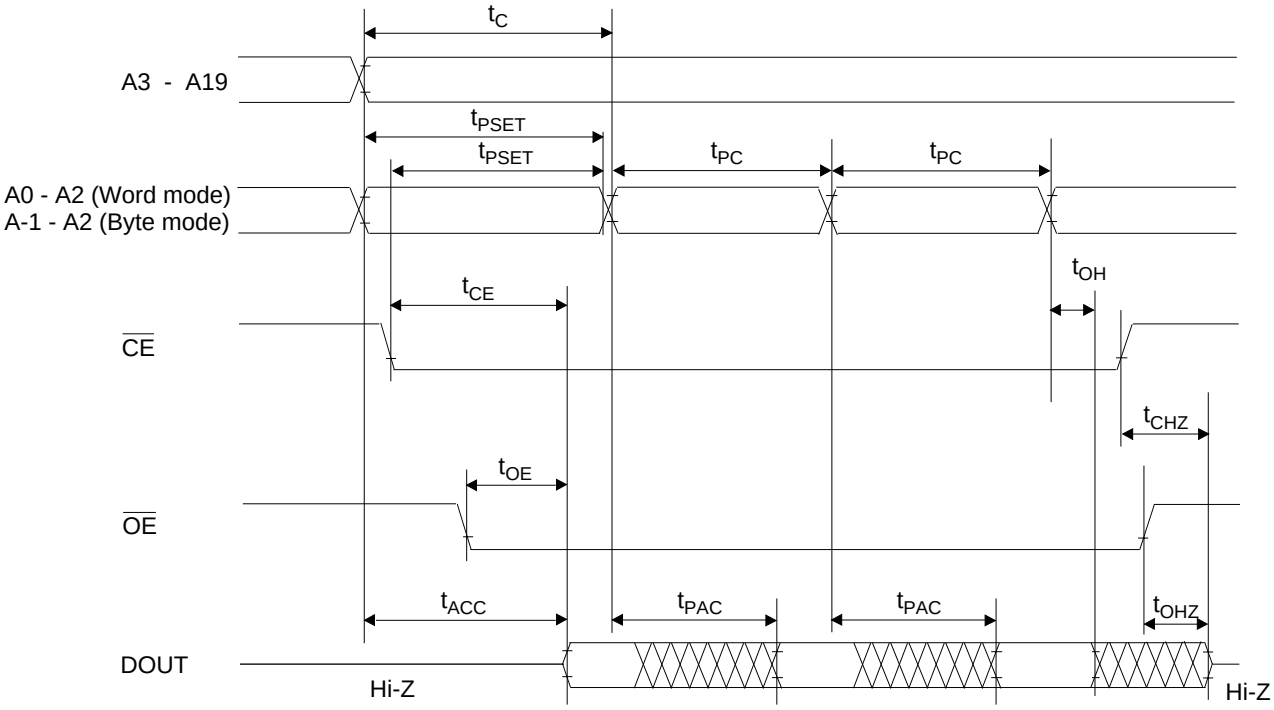


TIMING CHART

NORMAL MODE READ CYCLE



PAGE MODE READ CYCLE



ELECTRICAL CHARACTERISTICS (Programming operation)

DC Characteristics

(Ta=25°C±5°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input leakage current	I_{LI}	$V_I=V_{CC}+0.5V$	-	-	10	µA
V_{PP} power supply current (Program)	I_{PP2}	$\overline{CE}=V_{IL}$	-	-	50	mA
V_{CC} power supply current	I_{CC}	-	-	-	80	mA
Input "H" level	V_{IH}	-	2.2	-	$V_{CC}+0.5$	V
Input "L" level	V_{IL}	-	-0.5	-	0.8	V
Output "H" level	V_{OH}	$I_{OH}=-400µA$	2.4	-	-	V
Output "L" level	V_{OL}	$I_{OL}=2.1mA$	-	-	0.45	V
Program voltage	V_{PP}	-	11.25	11.5	11.75	V
V_{CC} power supply voltage	V_{CC}	-	6.0	6.25	6.5	V

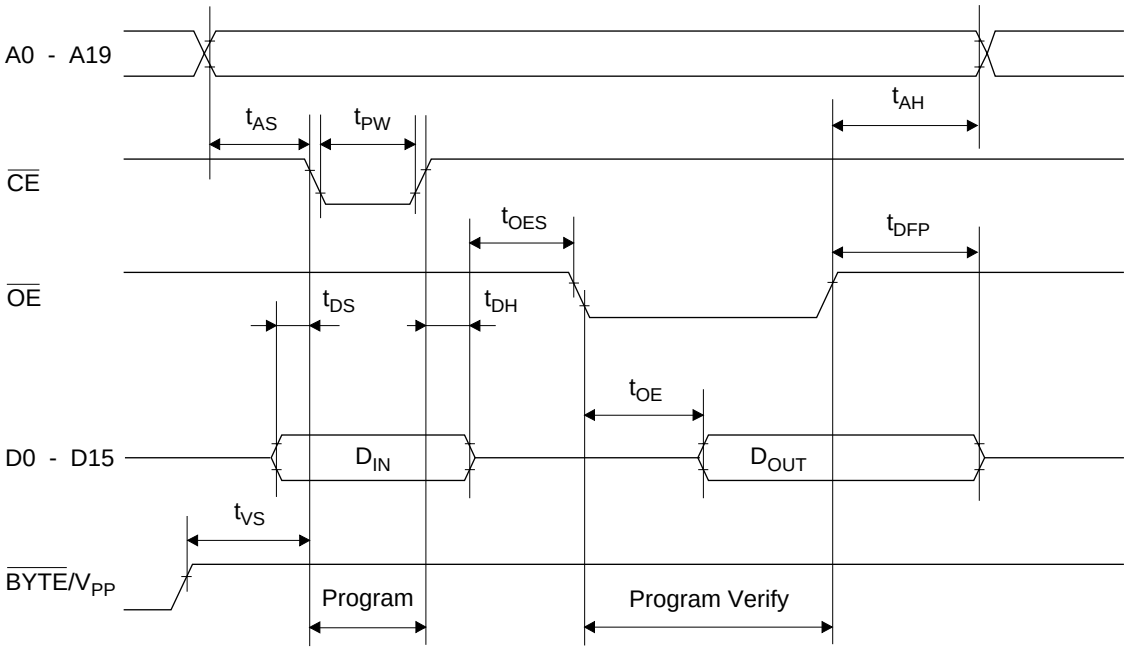
Voltage is relative to Vss

AC Characteristics

(V_{cc}=6.25V±0.25V,V_{pp}=11.5V±0.25V,Ta=25°C±5°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Address set-up time	T_{AS}	-	2	-	-	µs
$\overline{OE}$ set-up time	T_{OES}	-	2	-	-	µs
Data set-up time	T_{DS}	-	2	-	-	µs
Address hold time	T_{AH}	-	0	-	-	µs
Data hold time	T_{DH}	-	2	-	-	µs
Output float delay from $\overline{OE}$	T_{DFP}	-	0	-	130	ns
V_{PP} voltage set-up time	T_{VS}	-	2	-	-	µs
Program pulse width	T_{PW}	-	23	25	27	µs
Data valid from $\overline{OE}$	T_{OE}	-	-	-	150	ns

Programming Waveform

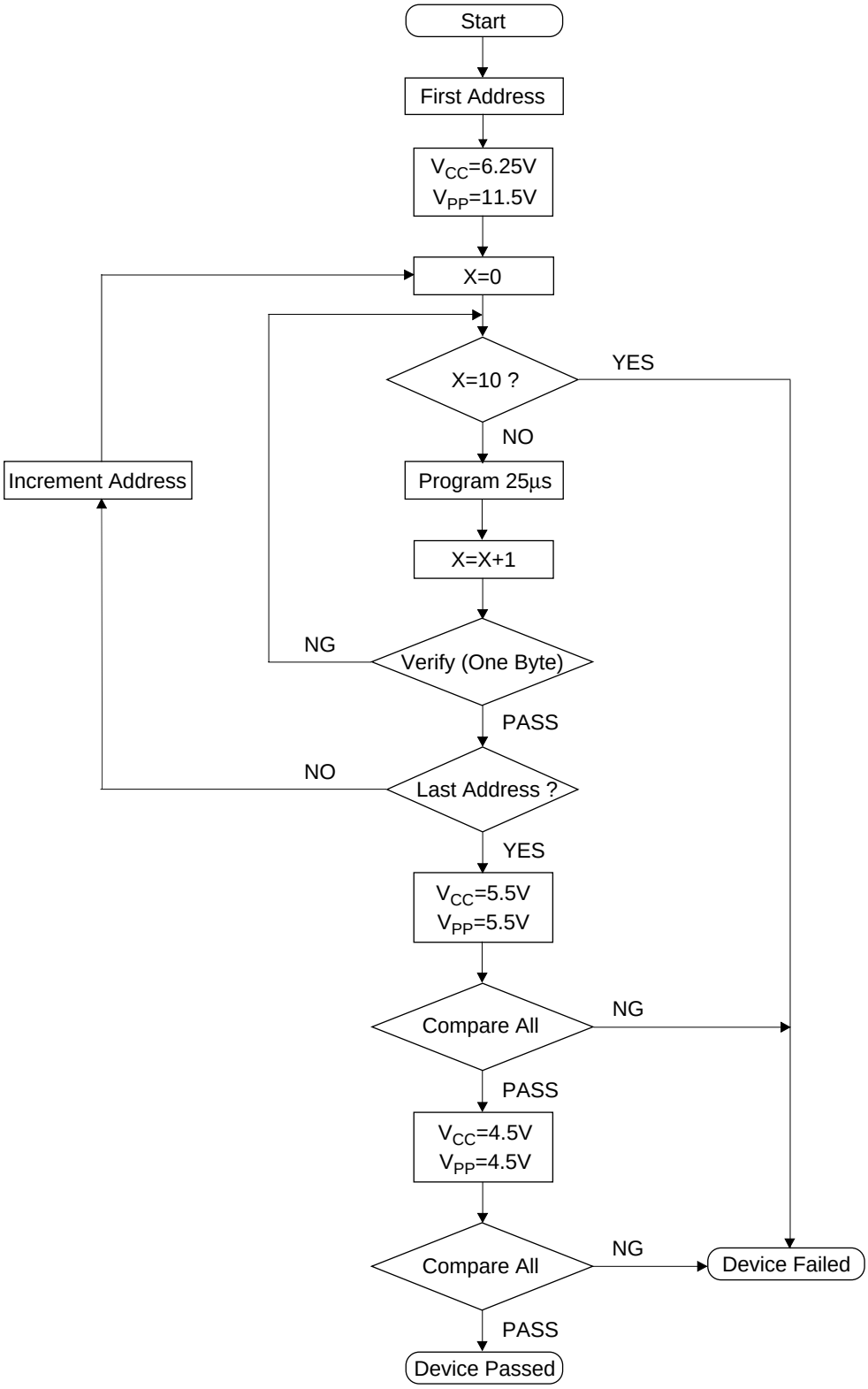


PIN Capacitance

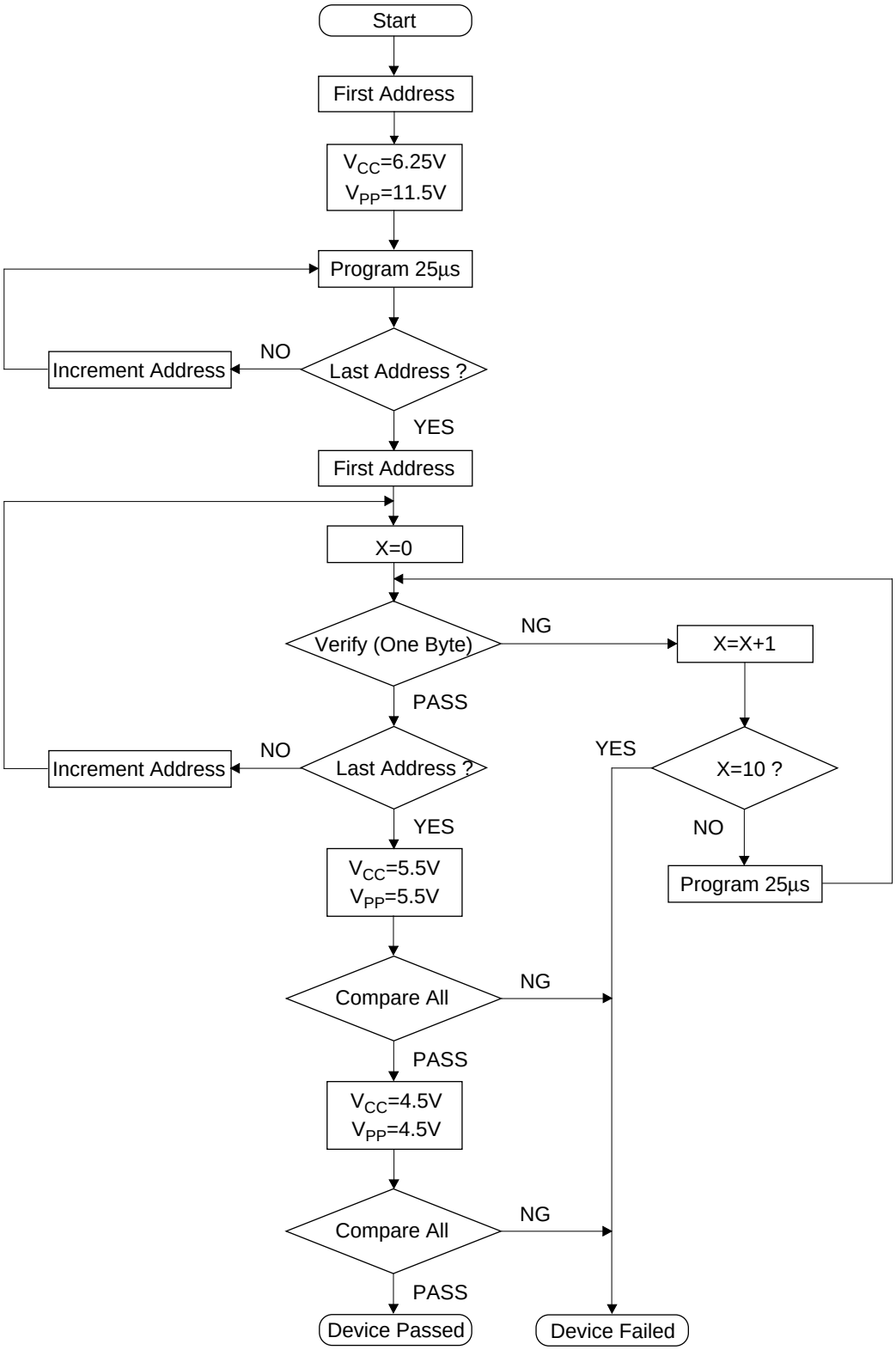
(V_{CC}=5V, Ta=25°C, f=1MHz)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input	C_{IN1}	V_I=0V	-	-	12	pF
$\overline{BYTE}/V_{PP}$	C_{IN2}		-	-	60	
Output	C_{OUT}	V_O=0V	-	-	15	

High Speed Programming Algorithm (I)



High Speed Programming Algorithm (II)



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